#### TOSHIBA BI-CMOS INTEGRATED CIRCUIT SILICON MONOLITHIC

# **TB62701AN**

#### 16BIT SHIFT REGISTER, LATCH & CONSTANT CURRENT DRIVERS

The TB62701AN is specifically designed for LED and LED-DISPLAY constant current drivers.

This constant current output circuit is able to set up external resister (IOUT = 5 to 50mA).

This IC is monolithic integrated circuit designed to be used together with Bi–CMOS process.

The devices consist of 16bit Shift Register, Latch, AND-GATE and Constant Current Driver.

#### **FEATURES**

- OUTPUT CURRENT: Set-up at 50mA maximum with an external resister.
- A LITTLE CHANGE OF OUTPUT CURRENT (Ta = 25°C, VDD = 5.0 V)

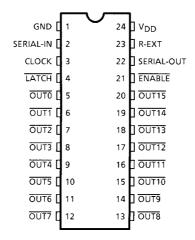
OUTPUT-GND VOLTAGE	A LITTLE CHANGE OF CHANNEL	I <sub>OUT</sub> [mA]		
≥ 0.4 V	± 7 %	5 ~ 50 mA		
≥ 0.7 V	± 7 76	5 ~ 50 IIIA		



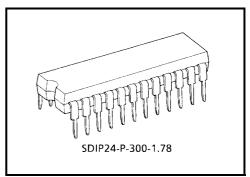
• PACKAGE : SDIP-24 (SDIP24-P-300)

• MAXIMUM CLOCK FREQUENCY :  $f_{MAX} = 2.5 \text{ MHz}$  (cascade operation,  $Ta = 25^{\circ}\text{C}$ )

### **PIN CONNECTION (TOP VIEW)**

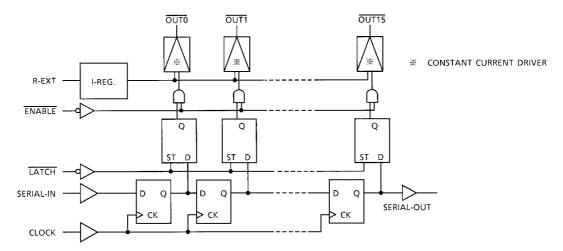


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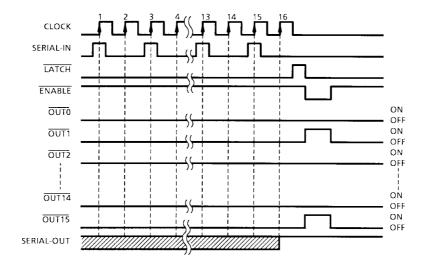


Weight: 1.22 g (typ.)

### **BLOCK DIAGRAM**



### **TIMING DIAGRAM**



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### **TERMINAL DESCRIPTION**

PIN No.	PIN NAME	FUNCTION
1	GND	GND terminal for control logic driver
2	SERIAL-IN	Serial data input terminal for shift register
3	CLOCK	Clock input terminal for data shift to up-edge
4	LATCH	"H" Level : data through, "L" Level : data hold
24	$V_{DD}$	Supply voltage terminal
5~12 13~20	OUTn	Output terminals
21	ENABLE	"H" Level output off, "L" Level : latch data = "H" Level then output on, latch data = "L" Level then output off
22	SERIAL-OUT	Serial data output terminal for shift register
23	R-EXT	The register which connects between R-EXT and GND sets the constant output current.

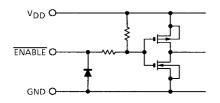
#### **TRUTH TABLE**

INPUT				OUTPUT OUTn (t = n)				
CLOCK	CLOCK LATCH ENABLE SERIAL-IN			OUT0 ··· OUT7 ··· OUT15	SERIAL-OUT			
	Н	L	D <sub>n</sub>	$D_n$ $D_{n-7}$ $D_{n-15}$	D <sub>n-15</sub>			
	L	L	D <sub>n</sub>	No change	D <sub>n-15</sub>			
	(Note)	Н	D <sub>n</sub>	OFF OFF OFF	D <sub>n-15</sub>			
	(Note)	(Note)	D <sub>n</sub>	No change	No change			

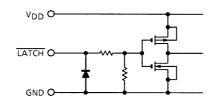
Note:  $D_{n}\sim D_{n-15}$  = "H" then OUTn is ON, "L" then OUTn is OFF.

### **EQUIVALENT CIRCUIT OF INPUTS AND OUTPUTS**

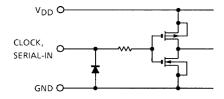
### 1. ENABLE terminal



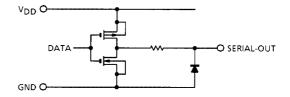
### 2. **LATCH** terminal



#### 3. CLOCK, SERIAL-IN terminal



### 4. SERIAL-OUT terminal



## MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Supply Voltage	$V_{DD}$	0~7.0	V
Output Voltage	V <sub>CE</sub>	-0.5~30	V
Output Current	lout	50	mA
Input Voltage	V <sub>IN</sub>	-0.4~V <sub>DD</sub> + 0.4	V
GND Terminal Current	I <sub>GND</sub>	800	mA
Clock Frequency	f <sub>CK</sub>	2.5	MHz
Power Dissipation (Note)	P <sub>D</sub>	1.78	W
Operating Temperature	T <sub>opr</sub>	-40~85	°C
Storage Temperature	T <sub>stg</sub>	-55~150	°C

Note: Ambient temperature delated above 25°C in the proportion of 14.2 mW / °C.

### RECOMMENDED OPERATING CONDITION (Ta = -40~85°C unless otherwise noted)

CHARACTERISTIC		SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
Supply Voltage		$V_{DD}$	_	4.5	5.0	5.5	V
Output Voltage		V <sub>OUT</sub>	_	_	_	30.0	V
	OUTn	lout	DC 1 circuit	_	_	45	
Output Current	S-OUT	Гон	_	_	_	-1.0	mA
	3-001	I <sub>OL</sub>	_	_	_	1.0	
Input Voltage		V <sub>IN</sub>	_	0	_	$V_{DD}$	V
Data Set Up Time		t <sub>setup</sub> (D)	_	100	_	_	ns
Data Hold Time		t <sub>hold (D)</sub>	_	20	_	_	ns
Data Set Up Time		t <sub>setup (L)</sub>	_	300	_	_	ns
Data Hold Time		t <sub>hold (L)</sub>	_	100	_	_	ns
Clock Pulse Width		tw clk	_	100			ns
Clock Pulse Width		tw CLK	_	100			ns
Latch Pulse Width		t <sub>W LAT</sub>	_	300			ns
Later Puise Width		t <sub>W</sub> LAT	_	300			ns
Clock Frequency		f <sub>CK</sub>	Cascade operation	_	_	2.0	MHz
Power Dissipation		PD	Ta = 85°C	_	_	0.72	W

# ELECTRICAL CHARACTERISTICS ( $V_{DD} = 5.0 \text{ V}$ , Ta = 25°C unless otherwise noted)

CHARACTERISTIC		SYMBOL	TEST CIR- CUIT	TEST CONDITION	MIN	TYP.	MAX	UNIT	
Input Leakage Current	"H" level	V <sub>IH</sub>	_	_	70% V <sub>DD</sub>	_	V <sub>DD</sub>		
	"L" level	V <sub>IL</sub>	_	_	GND	_	30%V DD	V	
Output Leakage Cu	ırrent	I <sub>OH</sub>	_	V <sub>OH</sub> = 30V	_	_	10	μA	
Output Votltage	S-OUT	$V_{OL}$	_	I <sub>OL</sub> = +1.0 mA	_	_	0.4	V	
Output Volitage	3-001	V <sub>OH</sub>	_	I <sub>OH</sub> = −1.0 mA	4.6	_	_	v	
Outroit Comment 1		I <sub>OL1</sub>	_	$V_{CE} = 0.7 \text{ V}$ $R_{EXT} = 560 \Omega$	35.2	41.5	47.7	mA	
Output Current 1		I <sub>OL2</sub>	_	$V_{CE} = 0.4 \text{ V}$ (included $\Delta I_{OL1}$ )	33.1	39.0	44.9	IIIA	
	Delta I <sub>OUT</sub>	Δl <sub>OL1</sub>	_	$R_{EXT}$ = 560 $\Omega$ $I_{OUT}$ = 40 mA, $V_{CE}$ = 0.4 V	_	±3.0	±7.0	%	
Supply Voltage Re	gulation	% / V <sub>DD</sub>	_	R <sub>EXT</sub> = 560 Ω	_	18	_	% / V	
Reference Voltage		V <sub>ref</sub>	_	R <sub>EXT</sub> = 560 Ω, Ta = -40~85°C	_	1.26	_	V	
Pull Up / Down Resister		R <sub>IN</sub>	_	_	100	200	400	kΩ	
	"OFF"	I <sub>DD</sub> (off) 1	_	R <sub>EXT</sub> = OPEN, OUTn = Off	_	0.4	0.6		
Supply Current		I <sub>DD (off) 2</sub>	_	$R_{EXT}$ = 560 Ω, OUTn = Off		6.5	10.0	mA	
	"ON"	I <sub>DD (on)</sub>	_	$R_{EXT}$ = 560 Ω, All output on		13.5	20.0		

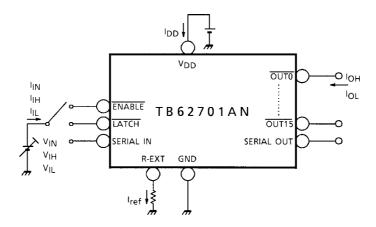
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# SWITCHING CHARACTERISTICS (Ta = 25°C unless otherwise noted)

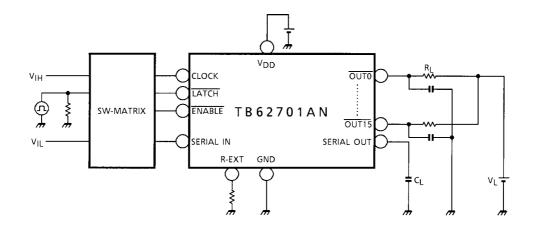
CHARACTE	ERISTIC	SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
Propagation Delay	CLK-S-OUT			_	95	500	ns
	CLK- OUTn			_	130	500	
Time ("L" to "H")	LATCH - OUTn	t <sub>pLH</sub>		_	130	500	
	EN - OUTn			_	130	500	
	CLK-S-OUT			_	95	720	
Propagation Delay	CLK- OUTn	<b>+</b>		_	130	500	ne
Time ("H" to "L")	LATCH - OUTn	t <sub>pHL</sub>		_	130	500	ns
	EN - OUTn			_	130	500	
Maximum Clock Frequency		f <sub>MAX</sub> (Note 1)	V <sub>DD</sub> = 5.0 V	2.0	_	2.5	MHz
Minimum Pulse	CLK	tw clk	$V_{CE} = 1.0 \text{ V}$ $V_{IH} = V_{DD}$ $V_{IL} = GNK$ $f_{CK} = 2 \text{ MHz}$ $R_{EXT} = 560 \Omega$	_	45	80	ns ns
Width	LATCH	t <sub>W</sub> LAT		_	10	50	
Data Set Up Time		t <sub>setup (D)</sub>		_	17	50	
Data Hold Time		t <sub>hold (D)</sub>	I <sub>OUT</sub> = 30 mA	_	-7	10	
Latch Set Up Time	LH	t LAT setup		_	70	200	ns
Later Set Op Time	HL			_	70	200	
Latch Hold Time	LH			_	-70	50	ns
HL		t LAT hold		_	-70	50	115
Maximum Clock Rise Time		t <sub>r</sub>			_	10	
Maximum Clock Fall Time		t <sub>f</sub>		_	_	10	μs
Maximum Output Rise Time		t <sub>or</sub>		_	35	80	- ns
Maximum Output Fall Time		t <sub>of</sub>		_	40	80	

Note 1: Cascade operation

### DC CHARACTERISTIC TEST CIRCUIT



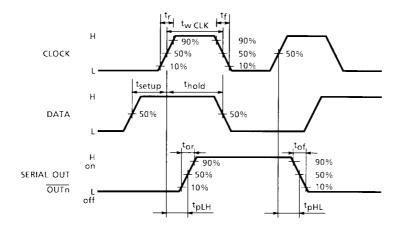
### **AC CHARACTERISTIC TEST CIRCUIT**



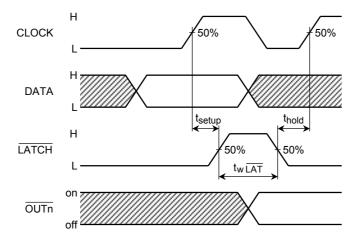
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### **TIMING WAVE FORM**

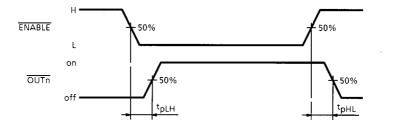
### 1. CLOCK-SERIAL OUT, OUTn



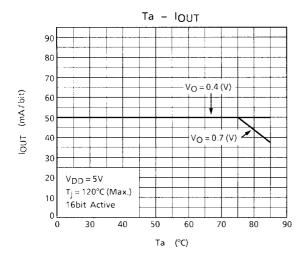
### 2. CLOCK-LATCH

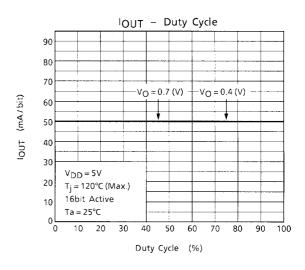


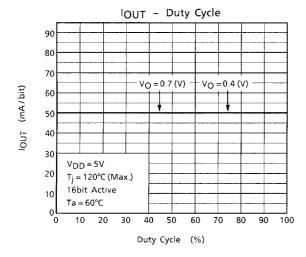
### 3. ENABLE

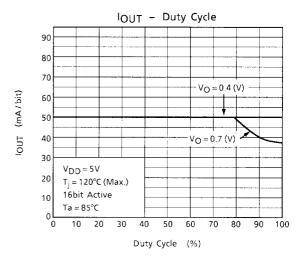


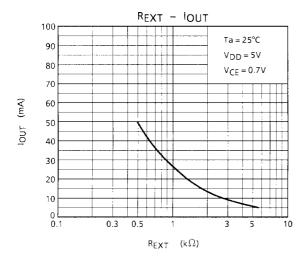
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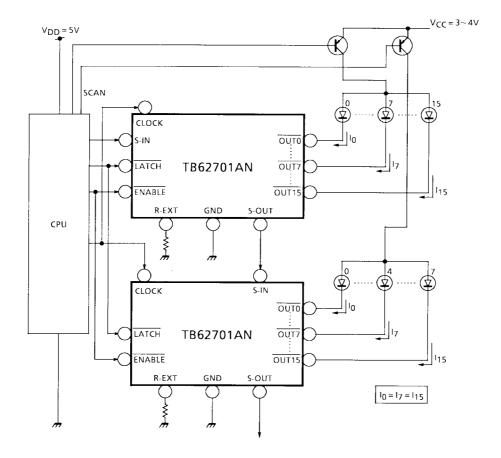






 $I_{OUT}$  (mA) = {1.26 (V)/R<sub>EXT</sub> ( $\Omega$ )} × 18.4

### **APPLICATION CIRCUIT**



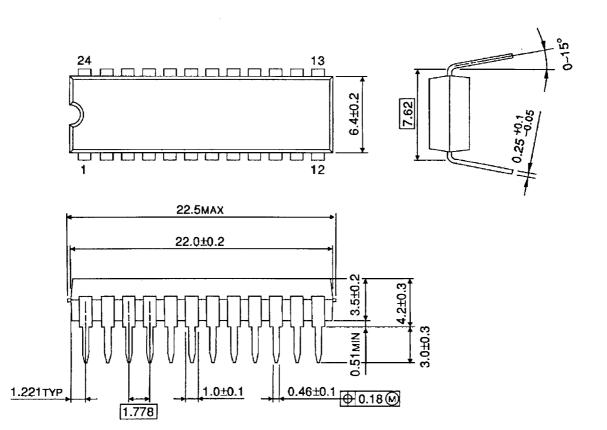
#### **PRECAUTIONS for USING**

Utmost care is necessary in the design of the output line,  $V_{CC}$  ( $V_{DD}$ ) and GND line since IC may be destroyed due to short–circuit between outputs, air contamination fault, or fault by improper grounding.

Unit: mm

### **Package Dimensions**

SDIP24-P-300-1.78



Weight: 1.22 g (typ.)

#### **RESTRICTIONS ON PRODUCT USE**

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